

SGM37603A High Efficiency 3-String White LED Driver

GENERAL DESCRIPTION

The SGM37603A is a high efficiency 3-string white LED driver with a 1.2MHz boost converter. The supply voltage operates from 3V to 24V. The SGM37603A is capable of driving up to 8 LEDs in series for 40mA maximum LED current per string while achieving high conversion efficiency. An adaptively current-regulated method allows different LED string voltages while LED current remains in regulation. The LED current is programmed through an I²C interface or a PWM signal input. These features make it optimized for compact solutions and ideal for LCD display backlighting.

The SGM37603A is available in Green WLCSP-1.78×1.36-12B and TDFN-3×3-12L packages. It operates over the -40°C to +85°C temperature range.

APPLICATIONS

Power Source for Smart Phone and Tablet Backlighting

FEATURES

- 12-Bit Resolution for Dimming Control
- Up to 90% Boost Efficiency
- Switching Frequency: 1.2MHz
- Support 1 to 3 LED Strings in Parallel at Maximum 29.5V Output
- 11% LED Current Matching across Process,
 Voltage and Temperature at I_{LED} = 12.21μA
- 1% LED Current Matching across Process,
 Voltage and Temperature at I_{LED} = 25mA
- 11% LED Current Accuracy across Process,
 Voltage and Temperature at I_{LED} = 12.21µA
- 3% LED Current Accuracy across Process,
 Voltage and Temperature at I_{LED} = 25mA
- PWM Dimming Interface
- Programmable I²C Interface
- Phase Shift Function
- Hybrid PWM + Current Dimming for Higher LED Driver Optical Efficiency
- Low EMI by Conducting Ringing Cancelling
- Protection Features
 - Over-Voltage Protection
 - Over-Current Protection
 - Thermal Shutdown

TYPICAL APPLICATION

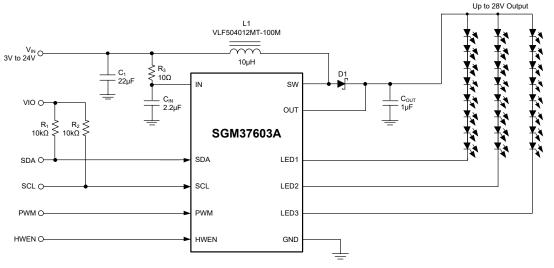


Figure 1. Typical Application



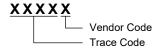
PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE		PACKAGE MARKING	PACKING OPTION
	WLCSP-1.78×1.36-12B	-40°C to +85°C	SGM37603AYG/TR	XXXXX GX3	Tape and Reel, 3000
SGM37603A	TDFN-3×3-12L	-40°C to +85°C	SGM37603AYTDF12G/TR	SGM B3DF XXXXX	Tape and Reel, 4000

MARKING INFORMATION

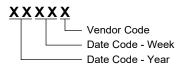
WLCSP-1.78×1.36-12B

XXXXX = Trace Code and Vendor Code.



TDFN-3×3-12L

XXXXX = Date Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

IN	0.3V to 28.6V
OUT	0.3V to 40V
SW	0.3V to 40V
LED1, LED2, LED3	0.3V to 17V
HWEN, PWM, SDA, SCL	0.3V to 6V
Package Thermal Resistance	
WLCSP-1.78×1.36-12B, θ _{JA}	82°C/W
TDFN-3×3-12L, θ _{JA}	50°C/W
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	2000V
MM	200V
CDM	500V

RECOMMENDED OPERATING CONDITIONS

IN	3V to 24V
OUT	0V to 30.5V
SW	0V to 30.5V
LED1, LED2, LED3	0V to 12V
HWEN, PWM, SDA, SCL	0V to 5.5V
Operating Temperature Range	40°C to +85°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

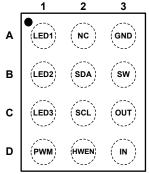
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

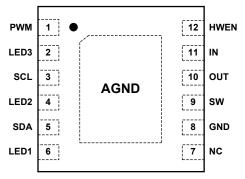
PIN CONFIGURATION

SGM37603A (TOP VIEW)



WLCSP-1.78×1.36-12B

SGM37603A (TOP VIEW)



TDFN-3×3-12L

PIN DESCRIPTION

PIN		NAME		FUNCTION
WLCSP-1.78×1.36-12B	TDFN-3×3-12L	NAME I/O		FUNCTION
A1	6	LED1	I	Current Sink 1. The boost converter regulates the minimum voltage between current sinks to V_{HR} .
A2	7	NC	_	No Connection.
A3	8	GND	0	Ground Pin.
B1	4	LED2	I	Current Sink 2. The boost converter regulates the minimum voltage between current sinks to V_{HR} .
B2 5		SDA	I/O	I ² C Data Signal.
В3	9	SW	I	Drain Connection for Internal Low-side N-Channel MOSFET. Connect to the anode of an external Schottky diode.
C1	2	LED3	I	Current Sink 3. The boost converter regulates the minimum voltage between current sinks to V_{HR} .
C2	3	SCL	I	I ² C Clock Signal.
C3	10	OUT	I	Output Voltage Sense Pin. It is used for sensing the output voltage for over-voltage protection. Connect to the positive terminal of the output capacitor.
D1	1	PWM	I	PWM Dimming Signal Input.
D2 12		HWEN	I	Hardware Enable Input Pin. Drive HWEN high to enable the device and allow I ² C write commands or PWM control.
D3	11	IN	ı	Input Supply Pin. Connect a at least 2.2 μF bypass capacitor from IN to GND.
	Exposed Pad	AGND	_	Power Ground Exposed Pad. It should be connected to ground plane.

NOTE: I: input; O: output; I/O: input or output.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 3.6V, Full = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ typical values are at } T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS	
BOOST								
LED Current Metching L. to L. to L.	I _{MATCH} (1)	I _{LED} = 12.21μA, V _{LED} = 300mV	+25°C		11		%	
LED Current Matching I _{LED1} to I _{LED2} to I _{LED3}	IMATCH	I _{LED} = 25mA, V _{LED} = 180mV	+25°C		1			
Absolute Acquirecy (I I)		$I_{LED} = 12.21 \mu A, V_{LED} = 300 mV$	+25°C		11		- %	
Absolute Accuracy (I _{LED1} , I _{LED2} , I _{LED3})		I _{LED} = 25mA, V _{LED} = 180mV	+25°C		3		70	
Minimum LED Current (per string)	I _{LED_MIN}		+25°C		12.21		μΑ	
Maximum LED Current (per string)	I _{LED_MAX}		+25°C		25		mA	
Regulated Current Sink Headroom Voltage	V_{HR}	I _{LED} = 25mA	+25°C		180		mV	
NMOS Switch On-Resistance	R _{NMOS}	I _{SW} = 250mA	+25°C		0.25	0.35	Ω	
NMOS Switch Current Limit	I _{CL}		+25°C	1.7	2.2	2.7	Α	
Output Over-Voltage Protection	V _{OVP}		Full	28.5	29.5	30.5	V	
OVP Hysteresis			+25°C		3		V	
Switching Frequency	f _{SW}		Full	950	1200	1400	kHz	
Maximum Boost Duty Cycle	D _{MAX}		Full	90	94		%	
Shutdown Current	I _{SHDN}	Chip enable bit = 0, SDA = SCL = IN or GND	+25°C		0.5	1.5	μΑ	
Thermal Shutdown	т				160		00	
Thermal Shutdown Hysteresis	T_{SD}				20		°C	
PWM INPUT								
PWM Dimming Frequency Range	DFR		+25°C	20		100	kHz	
Turn-On Delay from Shutdown to Backlight On	t _{START-UP}	PWM input active, PWM = logic high, HWEN input from low to high, f _{PWM} = 20kHz (50% duty cycle)	+25°C		10		ms	
Input Logic High	V _{IH}	HWEN, SCL, SDA, PWM inputs	Full	1.4			V	
Input Logic Low	V _{IL}	HWEN, SCL, SDA, PWM inputs	Full			0.4	V	

NOTE:

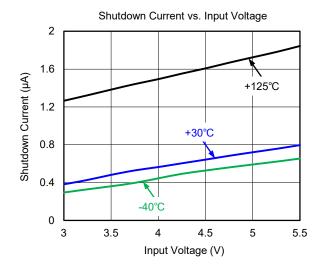
1. LED Current Matching between strings is given as the worst case matching between any two strings. Matching is calculated as $(I_{LEDX} - I_{LEDY})/(I_{LEDX} + I_{LEDY}) \times 100$.

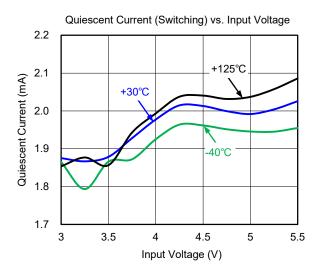
I²C TIMING REQUIREMENTS

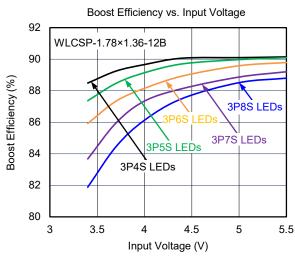
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS
SCL Clock Period	t ₁	2.5			μs
Data in Setup Time to SCL High	t ₂	100			ns
Data Out Stable After SCL Low	t ₃	0			ns
SDA Low Setup Time to SCL Low (Start)	t ₄	100			ns
SDA High Hold Time After SCL High (Stop)	t ₅	100			ns

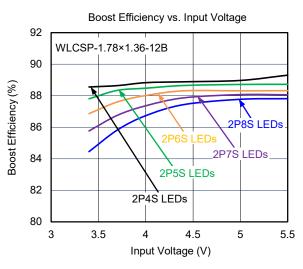
TYPICAL PERFORMANCE CHARACTERISTICS

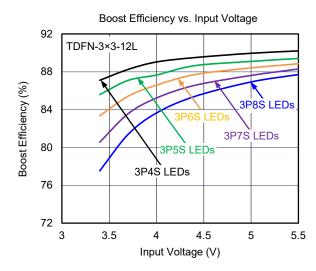
At $T_A = +25^{\circ}\text{C}$, $V_{IN} = 3.7\text{V}$, L1 = $10\mu\text{H}$ (VLF504012MT-100M), D1 = NSR0530P2T5G, unless otherwise noted.

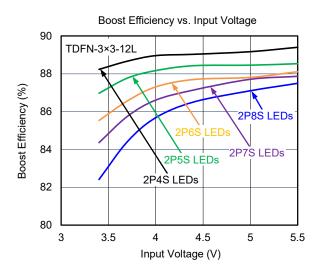






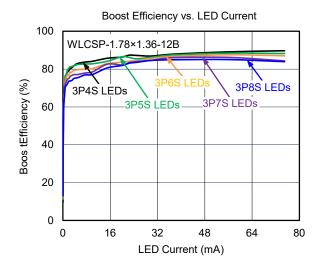


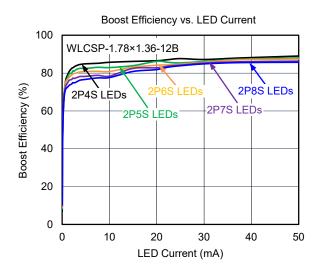


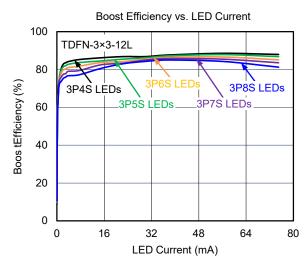


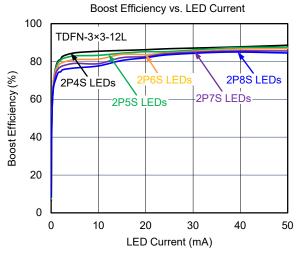
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

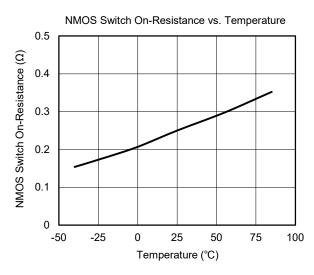
At $T_A = +25^{\circ}\text{C}$, $V_{IN} = 3.7\text{V}$, L1 = $10\mu\text{H}$ (VLF504012MT-100M), D1 = NSR0530P2T5G, unless otherwise noted.

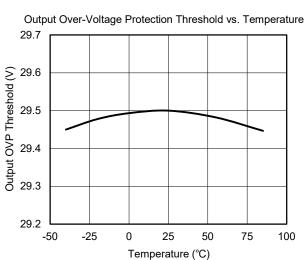






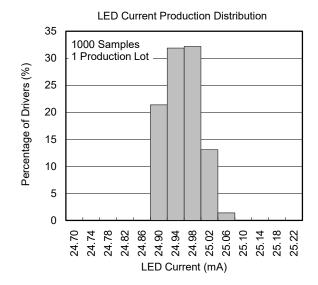






TYPICAL PERFORMANCE CHARACTERISTICS (continued)

At $T_A = +25^{\circ}\text{C}$, $V_{IN} = 3.7\text{V}$, L1 = $10\mu\text{H}$ (VLF504012MT-100M), D1 = NSR0530P2T5G, unless otherwise noted.





FUNCTIONAL BLOCK DIAGRAM

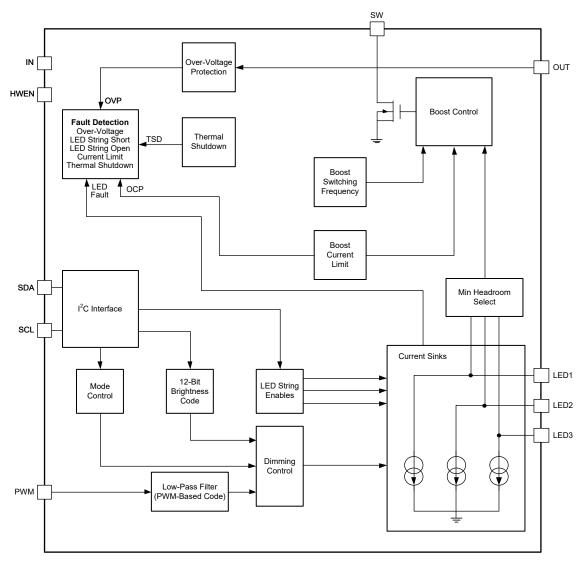


Figure 2. Functional Block Diagram

REGISTER MAP

All registers are 8-bit and individual bits are named from D[0] (LSB) to D[7] (MSB).

R/W: Read/Write bit(s)
R: Read only bit(s)
PORV: Power-On Reset Value

I²C Slave Address of SGM37603A is: 0x36 (0b0110110 + R/W)

Table 1. Register Map

ADDRESS	REGISTER NAME	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
0x01	Software Reset								SOFT_RST
0x10	Enable Control		Reserved		RSD_FL	LED3_EN	LED2_EN	LED1_EN	DEV_EN
0x11	Brightness Control	Reserved	Reserved LED_MOD[1:0] RAMP_EN Reserved						
0x1A	Brightness Code 0		Rese	erved		BRT_COD[3:0]			
0x19	Brightness Code 1		BRT_COD[11:4]						
0x1F	Fault Information		Reserved		SO_FLAG	SC_FLAG	TSD_FLAG	OC_FLAG	OVP_FLAG
0x1B	Maximum LED Current			Rese	erved		•	ILED_M	IAX[1:0]

Table 2. Software Reset Register Details (Register Address: 0x01)

BITS	BIT NAME	DESCRIPTION	PORV	TYPE
D[7:1]	Reserved	Reserved	0000000	R
D[0]	SOFT_RST	Software Reset 0 = Normal Operation 1 = Reset the device. It will return 0 automatically.	0	R/W

Table 3. Enable Control Register Details (Register Address: 0x10)

BITS	BIT NAME	DESCRIPTION	PORV	TYPE
D[7:5]	Reserved	Reserved	000	R
D[4]	RSD_FL	Reserved Flag. It is set to 1 by default.	1	R/W
D[3]	LED3_EN	LED3 Enable 0 = Disabled 1 = Enabled (default)	1	R/W
D[2]	LED2_EN	LED2 Enable 0 = Disabled 1 = Enabled (default)	1	R/W
D[1]	LED1_EN	LED1 Enable 0 = Disabled 1 = Enabled (default)	1	R/W
D[0]	DEV_EN	Device Enable 0 = Disabled 1 = Enabled (default)	1	R/W

REGISTER MAP (continued)

Table 4. Brightness Control Register Details (Register Address: 0x11)

BITS	BIT NAME	DESCRIPTION	PORV	TYPE
D[7]	Reserved	Reserved	0	R
D[6:5]	LED_MOD[1:0]	$00 = I^2C \text{ Only}$ $01 = PWM \text{ Only}$ $10 = I^2C \times PWM$ $11 = I^2C \times PWM \text{ (default)}$	11	R/W
D[4]	RAMP_EN	Ramp Enable 0 = Disabled (default) 1 = Enabled	0	R/W
D[3:0]	Reserved	Reserved	0101	R

Table 5. Brightness Code 0 Register Details (Register Address: 0x1A)

BITS	BIT NAME	DESCRIPTION	PORV	TYPE
D[7:4]	Reserved	Reserved	1111	R
D[3:0]	BRT_COD[3:0]	Lower 4 Bits of the 12-Bit Brightness Code	1111	R/W

Table 6. Brightness Code 1 Register Details (Register Address: 0x19)

BITS	BIT NAME	DESCRIPTION	PORV	TYPE
D[7:0]	BRT_COD[11:4]	High Byte of the 12-Bit Brightness Code	11111111	R/W

Table 7. Fault Information Register Details (Register Address: 0x1F)

BITS	BIT NAME	DESCRIPTION	PORV	TYPE
D[7:5]	Reserved	Reserved	000	R
D[4]	SO_FLAG	LED String Open Fault Flag 0 = No LED Open Fault (default) 1 = LED Open Fault	0	R
D[3]	SC_FLAG	Short Circuit Fault Flag 0 = No short-circuit fault (default) 1 = Short-circuit fault	0	R
D[2]	TSD_FLAG	Thermal Shutdown Fault Flag 0 = No thermal shutdown fault (default) 1 = Thermal shutdown fault	0	R
D[1]	OC_FLAG	Current Limit Fault Flag 0 = No current limit fault 1 = Current limit fault	0	R
D[0]	OVP_FLAG	Output Over-Voltage Fault Flag 0 = No over-voltage fault (default) 1 = Over-voltage fault	0	R

Table 8. Maximum LED Current Register Details (0x1B)

BITS	BIT NAME	DESCRIPTION	PORV	TYPE
D[7:2]	Reserved	Reserved	000000	R
D[1:0]	ILED_MAX[1:0]	Maximum LED Current Setting 00 = Maximum LED Current of 25mA (default) 01 = Maximum LED Current of 30mA 10 = Maximum LED Current of 35mA 11 = Maximum LED Current of 40mA	00	R/W



DETAILED DESCRIPTION

Table 9. SGM37603A Operating Modes

Device Enable DEV_EN Bit	LED Enable LED1_EN & LED2_EN & LED3_EN Bits	PWM Input	I ² C Brightness Code BRT_COD[11:0]	Brightness Mode LED_MOD[1:0]	LED Current
0	XXX	Х	XXX	XX	Off, device disabled
1	000	Х	XXX	XX	Boost enabled, LED current disabled
1	At least one enabled	X	000	00	Off, device in standby mode
1	At least one enabled	Х	Code > 000	00	See (1)
1	At least one enabled	0	XXX	01	Off, device in standby mode
1	At least one enabled	PWM Signal	XXX (2)	01	See (1)
1	At least one enabled	0	XXX	10 or 11	Off, device in standby mode
1	At least one enabled	Х	000	10 or 11	Off, device in standby mode
1	At least one enabled	PWM Signal	Code > 000	10 or 11	See (1)

NOTE:

- 1. I_{LED} is calculated by the equations from Equation 1 to Equation 8 below in Brightness Control Modes.
- 2. Code is forbidden to set to 0.

Brightness Control Modes

The SGM37603A has 3 brightness control modes:

- 1. I²C Only (brightness mode 00)
- 2. PWM Only (brightness mode 01)
- 3. $I^2C \times PWM$ (brightness mode 10 or 11)

I²C Only (Brightness Mode 00)

In brightness control mode 00, only the I²C Brightness registers control the LED current. The 12-bit code (0 to 4095) is in control of the LED current as follows:

When the code is from 256 to 4095, the average LED current increases proportionally to the brightness code and follows the below relationship (see Figure 4).

When the code is an odd integer,

$$I_{LED AVG} = 12.21 \mu A \times 0.5 \times (code - 1)$$
 (1)

When the code is an even integer,

$$I_{LED_AVG} = 12.21\mu A \times 0.5 \times code$$
 (2)

Where:

I_{LED AVG} = average LED current

When the code is from 16 to 255, the average LED current is calculated by Equation 1 and Equation 2 and the LED current is in current-to-PWM control (see Figure 4) with a constant maximum current, while the duty cycle changes following the code.

When the code is from 1 to 15, the average LED current increases exponentially to the brightness code and follows the relationship by Equation 3 (see Figure 4). The LED current is also in current-to-PWM control, and the duty cycle is 16/256 constantly, and the amplitude of current pulse is 16 times of its corresponding average current.

$$I_{LED_AVG} = 12.21 \mu A \times 1.149^{(\text{code - 1})}$$
 (3)

Code 1 programs the LED current to 12.21µA with 25mA maximum LED current. If the bits[1:0] are not set to all 0 in register 0x1B, the maximum LED current will increase and the minimum current (code = 1) will proportionally increase. Code 0 programs 0 current.

When bit[4] is set to 1 in register 0x11, ramp function is enabled. Then when bits[7:4] in registers 0x19 are not all 0 (codes from 256 to 4095), the ramp rate is 128µs/step. When bits[7:4] in registers 0x19 are all 0 (codes from 1 to 255), the ramp rate is 1024µs/step. For example, if the code is set from 2000 to 4001, I_{LED AVG} will change from 12.21mA to 24.42mA, the corresponding ramp rate = 128µs/step, so the ramp time for $I_{LED\ AVG}$ = [(4001 - 1) × 0.5 - 2000 × 0.5] × $128\mu s = 128ms$.

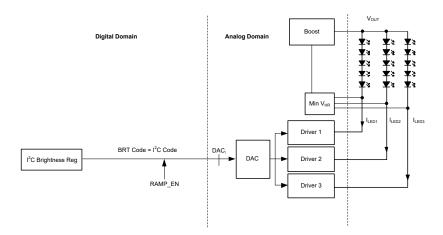


Figure 3. Brightness Control 00 (I²C Only)

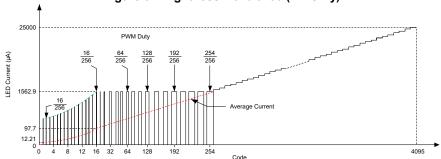


Figure 4. LED Current vs. Brightness Code (Mode 00)



PWM Only (Brightness Mode 01)

In brightness mode 01, only the PWM signal input sets the brightness. The I^2C code is ignored and forbidden to set to 0. The LED current is proportional with the PWM duty cycle and the maximum LED current is 25mA.

When the PWM pin is constantly high, the V_{REF} voltage is regulated to 2048mV typically. When the duty cycle of the input PWM signal is low, the regulation voltage is reduced, and the LED current is reduced; therefore, it achieves LED brightness dimming. The relationship between the duty cycle and V_{REF} regulation voltage is given by Equation 4:

$$V_{REF} = Duty \times 2048mV$$
 (4)

Where:

Duty = duty cycle of the PWM signal 2048mV = internal reference voltage

Then the value of V_{REF} is the PWM-based code for brightness dimming. The LED current increases proportionally to the brightness code and follows the relationship (see Figure 6):

$$I_{LED AVG} = 12.21 \mu A \times code$$
 (5)

This is valid from codes 1 to 2048. Code 0 programs 0 current. When the code < 16, the LED current is in current-to-PWM control. The duty cycle of the PWM is 1/8, and the amplitude of current pulse is 8 times of its corresponding average current. Figure 6 (a) shows the zoomed graph from codes 0 to 16 in Figure 6. There is no ramp function in this mode.

Thus, the user can easily control the WLED brightness by controlling the duty cycle of the PWM signal. The PWM frequency is in the range from 20kHz to 100kHz.

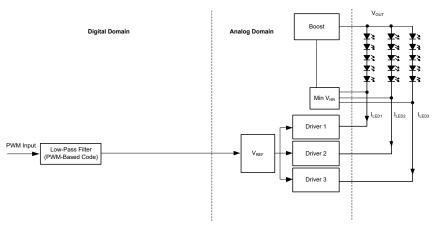


Figure 5. Brightness Control 01 (PWM Only)

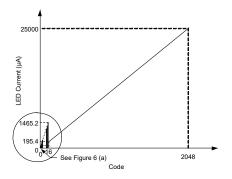


Figure 6. LED Current vs. Brightness Code (Mode 01)

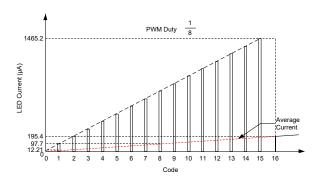


Figure 6 (a).

I²C + PWM (Brightness Mode 10 or 11)

In brightness control mode 10 or 11, both the I²C code and the PWM duty cycle control the LED current. The brightness code is calculated by PWM duty cycle and the I²C brightness code, and follows the relationship (see Figure 7):

When the I²C code is an odd integer,

BRT code = $(I^2C \text{ code - 1}) \times 0.5 \times PWM \text{ duty cycle } (6)$

When the I²C code is an even integer,

BRT code = I^2C code × 0.5 × PWM duty cycle (7)

Where:

BRT code = the brightness code

I²C codes are valid from 0 to 4095. The codes should be integers.

The average LED current increases proportionally to the brightness code and is calculated by Equation 8.

$$I_{LED AVG} = 12.21 \mu A \times code$$
 (8)

This is valid from codes 1 to 2047 and the codes could be integers or decimals. Code 1 programs the LED current to 12.21 μ A with 25mA maximum LED current. If the bits[1:0] are not set to all 0 in register 0x1B, the maximum LED current will increase and the minimum current (code = 1) will proportionally increase. Code 0 programs 0 current (see Figure 8). When the brightness code < 16, the LED current is in current-to-PWM control. The duty cycle of the PWM is 1/8, and the amplitude of current pulse is 8 times of its corresponding average current. Figure 8 (a) shows the zoomed graph from codes 0 to 16 in Figure 8.

When bit[4] is set to 1 in register 0x11, ramp function is enabled . When bits[7:4] in registers 0x19 are not all 0 (codes from 256 to 4095), regardless of PWM duty cycle, the ramp rate is 128µs/step. When bits[7:4] in registers 0x19 are all 0 (codes from 1 to 255), regardless of PWM duty cycle, the ramp rate is 1024µs/step. For example, if PWM duty cycle is set to 10% and the code is set from 2000 to 4001, bit[1:0] in register 0x1B is 00, I_{LED_AVG} will change from 1.221mA to 2.442mA, the corresponding ramp rate = 128µs/step, so the ramp time for I_{LED_AVG} = [(4001 - 1) × 0.5 - 2000 × 0.5] × 128µs = 128ms.

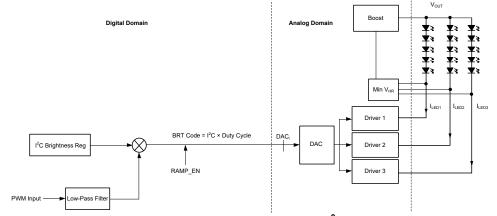


Figure 7. Brightness Control 10 or 11 (I²C + PWM)

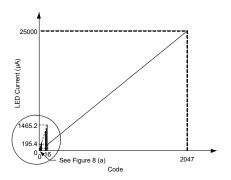


Figure 8. LED Current vs. Brightness Code (Mode 10 or Mode 11)

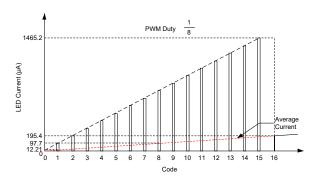


Figure 8 (a).



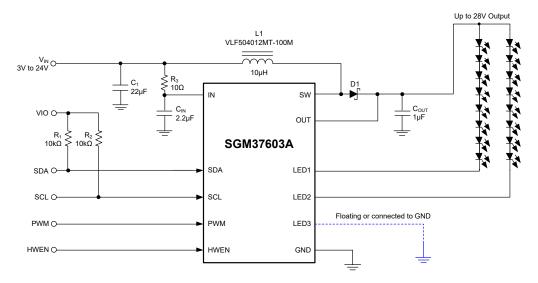


Figure 9. Typical Application for Less than Three Parallel LED Strings

REVISION HISTORY

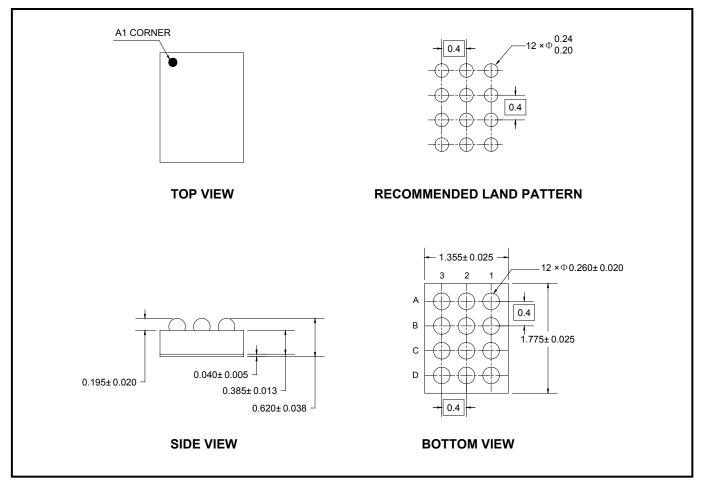
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

SEPTEMBER 2021 - REV.A.1 to REV.A.2

Changed Marking Information section.	2
JANUARY 2019 – REV.A to REV.A.1	
Changed Register Maps section	10
Changed Detailed Description section	17
Changes from Original (SEPTEMBER 2018) to REV.A	
Changed from product preview to production data	All

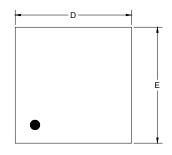
PACKAGE OUTLINE DIMENSIONS

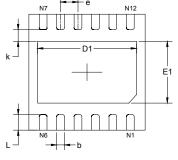
WLCSP-1.78×1.36-12B



NOTE: All linear dimensions are in millimeters.

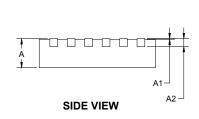
PACKAGE OUTLINE DIMENSIONS TDFN-3×3-12L

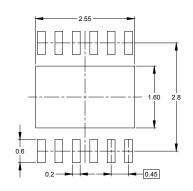




TOP VIEW





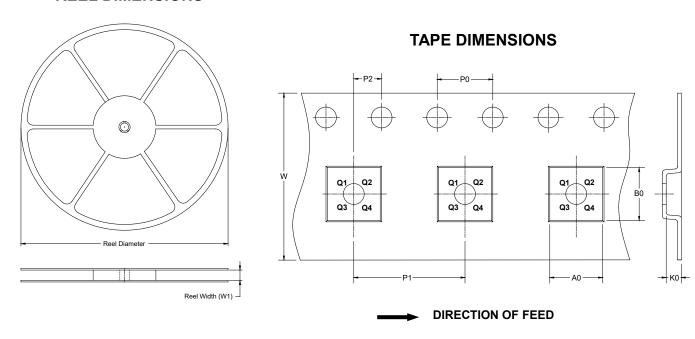


RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	_	nsions meters	Dimen In Inc	
	MIN	MAX	MIN	MAX
Α	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203 REF		0.008	REF
D	D 2.924		0.115	0.121
D1	2.450	2.650	0.096	0.104
E	2.924	3.076	0.115	0.121
E1	1.500	1.700	0.059	0.067
k	0.200	0.200 MIN		MIN
b	0.150 0.250		0.006	0.010
е	0.450 TYP		0.018	TYP
L	0.324	0.476	0.013	0.019

TAPE AND REEL INFORMATION

REEL DIMENSIONS

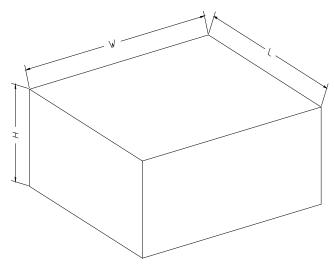


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant	
WLCSP-1.78×1.36-12B	7"	9.2	1.46	1.90	0.81	4.0	4.0	2.0	8.0	Q1	
TDFN-3×3-12L	13"	12.4	3.30	3.30	1.10	4.0	8.0	2.0	12.0	Q1	DD0001

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18
13"	386	280	370	5